

DATA SHEET

OLS449, OLC449, OLF449, OLH449: Radiation-Tolerant, Transistor Output Optocoupler with Base Connection

Applications

- Aerospace
- Defense
- Industrial
- Commercial

Features

- High voltage electrical isolation
- High CTR assured over –55° to +125 °C
- Low input current: 1 mA
- Comparable to OLx249 family, but featuring higher CTR
- CMOS to LSTTL or TTL compatibility
 - Various packages available to fit application
 - Small footprint, hermetic packages (LCC, FP, TO-5)
 - Cost-effective package (Glob Top SMT)
- Radiation-tolerant version of 4N49U
- High-reliability screening available
 - MIL-STD-883 Class B equivalent
 - MIL-PRF-19500 JAN, JANTX, JANTXV, JANS equivalent
 - MIL-PRF-38534 Class H, K equivalent
 - Per customer requirements
- For RoHS and other product compliance information, see the Skyworks Certificate of Conformance.

Description

The OLx449 is designed for low input current applications that require optical isolation with a high CTR and low saturation VCE. Each optocoupler



Figure 1. Block Diagram

consists of an LED and NPN silicon phototransistor that is electrically isolated, but optically coupled inside a hermetic (LCC, FP, TO-5) or non-hermetic (Glob Top) package.

Electrical parameters are comparable to the JEDEC registered 4N49 optocoupler, but with a higher CTR and better CTR degradation characteristics due to radiation exposure.

OLx449 devices are offered as unscreened versions as well as screened to customer requirements, including MIL-STD-883 Class B equivalent, MIL-PRF-19500 JAN, JANTX, JANTXV, JANS equivalent and MIL-PRF-38534 Class H, K equivalent.





2: N/C

Hermetic 8-Lead Flatpack (OLF449YYY-N)



Pins 3, 8: N/C Pin 4: Electrically connected to seal ring

Hermetic 6-Lead TO-5 (OLH449YYY-N)



Non-Hermetic 6-Lead Glob Top SMT (OLC449YYY-N)



Figure 2. Pinouts

Electrical and Mechanical Specifications

Table 1. OLx449 Absolute Maximum Ratings¹

(T _A = 25 °C, unless otherwise no
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Parameter	Symbol	Conditions	Min	Max	Units
Input					
Average forward current	I _{DD}			40	mA
Average forward current derating	$\Delta I_F / \Delta T_A$	T _A ≥65 °C		0.67	mA/°C
Peak forward current	١ _F	Pulsewidth \leq 1 uS, PRR \leq 300 pps		1	A
Reverse voltage	V _R			2	V
Input power dissipation	PD			70	mW
Output	ł		ł		4
Collector to emitter voltage	V _{CEO}			65	V
Emitter to base voltage	V _{EBO}			7	V
Collector to base voltage	V _{CBO}			65	V
Continuous collector current	I _{CC}			50	mA
Output power dissipation	PD			300	mW
Output power dissipation derating	$\Delta P_O / \Delta T_A$	T _A ≥25 °C		3.0	mW/°C
Coupler	4		1		
		T _A = 25 °C, duration = 1 s, OLS449	-1500	1500	V
Input to output isolation voltage ²	V _{DC}	T _A = 25 °C, duration = 1 s, OLC449/ OLF449/OLH449	-1000	1000	V
Storage temperature range	T _{STG}		-65	150	°C
Operating temperature range	T _A		-55	125	°C
Soldering temperature	T _{SLD}	< 10 seconds		240	°C
Electrostatic Discharge	,		,		
MIL-STD-883, Method 3015 Human Body Model (HBM)	ESD	Class 1C rating		2000	V

1. Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to the device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

 OLS449/OLC449: Measured between pins 1, 2, and 6 shorted together, and pins 3, 4, and 5 shorted together. OLF449: Measured between pins 1, 2, 3, and 4 shorted together, and pins 5, 6, 7, and 8 shorted together. OLH449: Measured between pins 5, 6, and 7 shorted together, and pins 1, 2, and 3 shorted together.

ESD Handling: Industry-standard ESD handling precautions must be adhered to at all times to avoid damage to this device.

Table 2. OLx449 Electrical Specifications¹

(T _A = 25 °C,	unless otherwise noted)
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Parameter	Symbol	Conditions	Min	Тур	Max	Units	
Input							
		I _F = 10.0 mA, 25 °C	1.2		1.7		
Forward voltage	V _F	I _F = 10.0 mA, 125 °C	1.1		1.6	v	
		I _F = 10.0 mA, -55 °C	1.3		1.9	1	
Reverse current	I _R	V _R = 2 V			100	μА	
Output							
Collector emitter breakdown voltage	BV _{CEO}	I _{CE} = 1 mA	65			v	
Collector base breakdown voltage	BV _{CBO}	I _{CB} = 100 μA	65			v	
Emitter base breakdown voltage	BV _{EBO}	I _{EB} = 100 μA	7			v	
Collector emitter dark current		I _F = 0 mA, V _{CE} = 20 V, 25 °C			100	nA	
	I _{CE_OFF}	I _F = 0 mA, V _{CE} = 20 V, 100 °C		50		μΑ	
		I _F = 0 mA, V _{CE} = 20 V, 125 °C			100	μΑ	
Collector base dark current	I _{CB_OFF}	I _F = 0 mA, V _{CB} = 20 V			10	nA	
Coupler							
		I _F = 1 mA, V _{CE} = 5 V, 25 °C	1500		4000		
Current transfer ratio (I _C /I _F)	CTR	R I _F = 1 mA, V _{CE} = 5 V, 125 °C 700				%	
		I _F = 1 mA, V _{CE} = 5 V, –55 °C	V, –55 °C 700				
Collector base current	I _{CB_ON}	I _F = 10 mA, V _{CB} = 5 V	300			μΑ	
Collector emitter saturation voltage	V _{CE_SAT}	I _F = 1 mA, I _C = 5 mA			0.3	v	
Output resistance ²	R _{I-O}	OLS449, V _{I-O} = ±1500 VDC		10 ¹¹		Ω	
		OLC449/OLF449/OLH449, V _{I-O} = ±1000 VDC		10			
Output capacitance ²	C _{I-O}	V _{I-O} = 0 V, f = 1 MHz			5	pF	
Switching Characteristics		•					
Rise time	t _r	Vcc = 10 V, I _F = 5 mA, R _L = 100 Ω			25	μs	
Fall time	t _f	-100 V			25	μs	

1. Performance is assured only under the conditions listed in the above table. Catalog OLx449 is 100% tested at 25 °C only.

OLS449/OLC449: Measured between pins 1, 2, and 6 shorted together, and pins 3, 4, and 5 shorted together.
OLF449: Measured between pins 1, 2, 3, and 4 shorted together, and pins 5, 6, 7, and 8 shorted together.
OLH449: Measured between pins 5, 6, and 7 shorted together, and pins 1, 2, and 3 shorted together.

 $T_A = 25 \text{ °C}$ and duration = 1 s.



Figure 3. Switching Test Circuit



Typical Performance Characteristics (T_A = 25 °C, Unless Otherwise Indicated)

Figure 4. Forward Current vs Diode Forward Voltage

Figure 5. Normalized Collector Current vs Forward Current



Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The OLC449 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C (Not applicable for hermetic devices.) For additional information, refer to the Skyworks Application Note, Solder Reflow Information, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment.



Figure 7. Package Dimensions, 6-Lead LCC





Figure 8. Part Marking, 6-Lead LCC





Figure 10. Part Marking, 8-Lead Flatpack





Figure 13. Package Dimensions, 6-Lead Glob Top SMT



Figure 14. Part Marking, 6-Lead Glob Top SMT

Lead Style	6-Lead LCC (OLS449YYY-N)	8-Lead Flatpack (OLF449YYY-N)	6-Lead TO-5 (OLH449YYY-N)	6-Lead Glob Top SMT (OLC449YYY-N)
	Surface mount	Surface mount	Through hole	Surface mount
Lead finish/plating	Min 60 μin Au over min 80 μin Ni	Min 60 μin Au over min 80 μin Ni	Min 50 μin Au over min 50 μin Ni	Min 2 μin Au over min 2 μin Pd and min 100 μin Ni
Lead thickness	N/A	5 mils	16 mils	N/A
Hermetic	Yes	Yes	Yes	No
CAGE code OJGG3				

	Table	4.	Related	Parts
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Part Number	Package	Description	Comments
OLS049	4-lead LCC		High CTR assured over –55 °C to 125 °C, 1000 VDC isolation voltage
OLC049	4-lead Glob Top		High CTR assured over –55 °C to 125 °C, 1000 VDC isolation voltage
OLS249	6-lead LCC	Radiation tolerant phototransistor, hermetic surface mount optocoupler with base connection	1500 VDC isolation voltage

Ordering Information



	Hermetic 6-Lead LCC	Hermetic 8-Lead Flatpack	Hermetic 6-Lead TO-5	Non-Hermetic 6-Lead Glob Top SMT
		-		-
Catalog	OLS449	OLF449	OLH449	OLC449
MIL-STD-883 Class B equivalent	OLS449SB	OLF449SB	OLH449SB	N/A
JANTX equivalent	OLS449SX	OLF449SX	OLH449SX	N/A
JANTXV equivalent	OLS449SXV	OLF449SXV	OLH449SXV	N/A
JANS equivalent	OLS449PS	OLF449PS	OLH449PS	N/A
Non-solder dipped and standard packing	Blank	Blank	Blank	Blank
Solder dipped	-1	-1	-1	N/A
Tape and reel	-2	N/A	N/A	N/A
Solder dip and tape and reel	-3	N/A	N/A	N/A
Standard packing	Tubes	Individual ESD carriers	Conductive carriers	Gel pack

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